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CONSUM





Alpha's mission is to be the industry's preferred supplier of <a href="https://mission.ni.nlm

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Today's consumer products require increased connectivity with their devices and smart learning features while maintaining the lowest total cost of ownership. Alpha's products enable consumer products to become more functional while also lowering their total manufacturing cost.











Electronic assemblies used in these products are becoming more complex in their design and require flexibility in processing. The products Alpha provides for this sub-market can be used in a wide variety of process conditions and enable fast throughput with high yields while also offering the lowest total cost of ownership.

Key Requirements:

- High performance under wide process conditions
- Excellent value, lowers total cost of ownership
- High mechanical and electrochemical reliability

CONSUMER: Whitegoods

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE
SMT – Printing and Dispensing		ALPHA® OM-358 SAC305 Ultralow voiding including bottom terminated components Excellent electrochemical reliability on bottom terminated components Good thermal cycling performance at temperatures <105°C		Pó	HF
		 ALPHA® CVP-390 SAC305 / SACX Plus 0307 Wide reflow process window Fine feature printability down to 01005 feature size Broad latitude paste for ultimate flexibility in manufacturing Available in low silver SACX Plus alloy(s) for improved value 		Pó	HF
	Solder Paste	 ALPHA® OM-353 SAC305 / SACX Plus 0307 Repeatable printing down to 0.3mm/.012" pitch and 01005 passives Lowest post reflow residue spread of Alpha's chemistries Low HIP and NWO Defects Available in low silver SACX Plus alloy(s) for improved value 		Pó	HF
		ALPHA® OM-550 HRL1 Best mechanical performance of Alpha's low temperature solder alloys Repeatable printing down to 0.3mm/.012" pitch and 01005 passives Significant reduction in warpage-induced defects such as HIP and NWO	l îs	Pó	HF
SMT –	Solder Paste	ALPHA® JP-510 SAC305 • Jettable to 0.5mm/.020" pitch • High mechanical and electrochemical reliability		<u>P6</u>	HF
Jetting		 ALPHA® JP-501 SnBiAg Low HIP and NWO Defects Jettable to 0.5mm/.020" pitch 	Lis	Pb	HF
SMT / PTH – Pick and Place	Preforms	ALPHA® BTC-578 Accuflux Preforms Innolot / SAC305 / Low-temp Increasing thermal conductivity and heat dissipation through void reduction Low flux residue improves electrochemical reliability Prevents mechanical stackup issues through increased solder volume	l îs	Pó	HF
		 ALPHA® Tape and Reel Preforms High solder volume precision and production yields using pick and place Available in many alloys, sizes and shapes Flux coated versions available (*some fluxes contain halogens) 	Lts	Pó	HF*
SMT / PTH – Point Soldering, Rework and Repair	Cored Wire	ALPHA® Telecore® HF-850 SAC305 / SACX Plus 0307 Performs well with all standard pad finishes Can be used in both robotic and manual soldering processes ROL0		Pb	HF
		 ALPHA® Telecore® XL-825 SAC305 / SACX Plus 0307 Best for difficult to solder surfaces Can be used in both robotic and manual soldering processes ROL1 		<u>P6</u>	

CONSUMER: Whitegoods continued

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE	VOC FREE
SMT – Dispensing	Adhesive	 ALPHA® HiTech™ SM42-1311 Non-Sagging Excellent adhesion on FR4 Resists change due to high heat post application processing (i.e., wave soldering) 			HF	
SMT – Printing	Adhesive	 ALPHA® HiTech™ SM42-120P Non-Sagging Excellent adhesion on FR4 Resists change due to high heat post application processing (i.e., wave soldering) 			HF	
	Bar and Solid Wire Solder	 ALPHA® SACX Plus 0307 Low Silver (0.3%) for improved value vs. SAC305 Low Copper dissolution and low drossing Excellent for most standard assemblies 		Pb		
		 ALPHA® SnCX Plus 07 Silver free for best value of SnCu alloys Low Copper dissolution and low drossing 		Pb		
	Liquid Flux	• ORLO • Passes IPC J-STD-004A • VOC free		Pb		Vijc
PTH – Wave / Selective Soldering		 ALPHA® EF-6000 ORL0 Passes IPC J-STD-004A High activity, rosin-free formula can be cleaned with DI water 		Pó		
		 ALPHA® EF-6103 ORL0 Passes IPC J-STD-004B Best for selective soldering processes 		Pb		
		 ALPHA® EF-9301 ROM1 Passes IPC J-STD-004A Excellent for common boards 		<u>P6</u>		
		 ALPHA® SLS-65C ORLO Passes IPC J-STD-004A Low residue, moderate activity 		<u>P6</u>	HF	



Improving the user's viewing experience is driving enhancements in display technology. Alpha's products contribute to maximizing display responsiveness and clarity and are able to be used in a wide variety of process conditions enabling fast throughput with high yields while also offering the lowest total cost of ownership.

Key Requirements:

- High thermal and electrical conductivity
- Performs well under wide process conditions
- Excellent value, lowers total cost of ownership
- High mechanical and electrochemical reliability

CONSUMER: Displays

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE
SMT – Printing and Dispensing		ALPHA® OM-358 SAC305 Ultralow voiding including bottom terminated components Excellent electrochemical reliability on bottom terminated components Good thermal cycling performance at temperatures <105°C ALPHA® CVP-390 SAC305 / SACX Plus 0307 Wide reflow process window Fine feature printability down to 01005 feature size Broad latitude paste for ultimate flexibility in manufacturing		Põ	H ²
	Solder Paste	Available in low silver SACX Plus alloy(s) for improved value ALPHA® OM-353 SAC305 / SACX Plus 0307 Repeatable printing down to 0.3mm/.012" pitch and 01005 passives Lowest post reflow residue spread of Alpha's chemistries Low HIP and NWO Defects Available in low silver SACX Plus alloy(s) for improved value		Pő	HF
		ALPHA® OM-550 HRL1 Best mechanical performance of Alpha's low temperature solder alloys Repeatable printing down to 0.3mm/.012" pitch and 01005 passives Significant reduction in warpage-induced defects such as HIP and NWO	Lts	Pó	HF
SMT –	Solder Paste	ALPHA® JP-510 SAC305 • Jettable to 0.5mm/.020" pitch • High mechanical and electrochemical reliability		Pb	HF
Jetting		 ALPHA® JP-501 SnBiAg Low HIP and NWO Defects Jettable to 0.5mm/.020" pitch 	Lis	Pb	HF
SMT / PTH – Pick and Place	Preforms	ALPHA® BTC-578 Accuflux Preforms Innolot / SAC305 / Low-temp Increasing thermal conductivity and heat dissipation through void reduction Low flux residue improves electrochemical reliability Prevents mechanical stackup issues through increased solder volume	Lts	Pó	HF
		 ALPHA® Tape and Reel Preforms High solder volume precision and production yields using pick and place Available in many alloys, sizes and shapes Flux coated versions available (*some fluxes contain halogens) 	Lts	Pó	HF*
SMT / PTH – Point Soldering, Rework and Repair	Cored Wire	ALPHA® Telecore® HF-850 SAC305 / SACX Plus 0307 • Performs well with all standard pad finishes • Can be used in both robotic and manual soldering processes • ROL0		Pb	HF
		 ALPHA® Telecore® XL-825 SAC305 / SACX Plus 0307 Best for difficult to solder surfaces Can be used in both robotic and manual soldering processes ROL1 		Pb	

CONSUMER: Displays continued

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE	VOC FREE
SMT – Dispensing	Adhesive	ALPHA® HiTech™ AD43-9600W • Good adhesion on FR4 and PMMA lens • Fast curing enabling high throughput manufacturing • White coloring eliminates 'flaring' during initial LED illumination ALPHA® HiTech™ SM42-1311 • Non-Sagging • Excellent adhesion on FR4 • Resists change due to high heat post application			H ³	
SMT – Printing	Adhesive	processing (i.e., wave soldering) ALPHA® HiTech™ SM42-120P Non-Sagging Excellent adhesion on FR4 Resists change due to high heat post application processing (i.e., wave soldering)			HF	
PTH – Wave / Selective Soldering	Bar and Solid Wire Solder	ALPHA® SACX Plus 0307 Low Silver (0.3%) for improved value vs. SAC305 Low Copper dissolution and low drossing Excellent for most standard assemblies ALPHA® SnCX Plus 07 Silver free for best value of SnCu alloys		P6		
	Liquid Flux	 Low Copper dissolution and low drossing ALPHA® EF-2210 ORL0 Passes IPC J-STD-004A VOC free 		Pi		VAC
		ALPHA® EF-6000 ORL0 Passes IPC J-STD-004A High activity, rosin-free formula can be cleaned with DI water		P6		
		 ALPHA® EF-6103 ORL0 Passes IPC J-STD-004B Best for selective soldering processes 		Pb		
		ALPHA® EF-9301 ROM1 Passes IPC J-STD-004A Excellent for common boards		Pb		
		 ALPHA® SLS-65C ORL0 Passes IPC J-STD-004A Low residue, moderate activity 		Pb	HF	



Alpha has the expertise to optimize the LED industry's technology drivers of cost per lumen, efficiency, brightness, and reliability over lifetime. Our value-adding product solutions positively impact each key step of the LED manufacturing process, from package on board through to the assemblies of the luminaire, power drive, and controls.

Key Requirements:

- High mechanical reliability
- High value, lowers total cost per lumen
- Maximizes light output with minimal degradation over time
- Transparent and minimal residues

CONSUMER: Lighting/LED

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE
	Solder Paste	 ALPHA® CVP-390 Innolot / SAC305 Excellent electrochemical reliability down to 0.100mm spacing Fine feature printability down to 01005 feature size Highest thermo-mechanical reliability at temperatures above 120°C (Innolot) 		Po	HF
SMT –		 ALPHA® OM-353 Innolot / SAC305 Lowest post reflow residue spread of Alpha's chemistries Excellent electrochemical reliability down to 0.200mm spacing Highest thermo-mechanical reliability at temperatures above 120°C (Innolot) 		Pó	HF
Printing and Dispensing		ALPHA® OM-358 Innolot / SAC305 Ultralow voiding on bottom terminated components Excellent electrochemical reliability on bottom terminated components Highest thermo-mechanical reliability at temperatures above 120°C (Innolot)		Pó	HF
		ALPHA® OM-550 HRL1 Best mechanical performance of Alpha's low temperature solder alloys Repeatable printing down to 0.3mm/.012" pitch and 01005 passives Significant reduction in warpage-induced defects	L	Pó	HF
SMT / PTH – Pick and Place	Preforms	ALPHA® BTC-578 Accuflux Preforms Innolot / SAC305 / Low-temp Increasing thermal conductivity and heat dissipation through void reduction Low flux residue improves electrochemical reliability Prevents mechanical stackup issues through increased solder volume	Lis	Pó	HF
		ALPHA® Tape and Reel Preforms High solder volume precision and production yields using pick and place Available in many alloys, sizes and shapes Flux coated versions available (*some fluxes contain halogens)	L	Pb	HF*
SMT / PTH – Point Soldering,	Cored Wire	ALPHA® Telecore® HF-850 Innolot / SAC305 • Performs well with all standard pad finishes • Can be used in both robotic and manual soldering processes • ROL0		Pb	HF
Rework and Repair		 ALPHA® Telecore® XL-825 SAC305 Best for difficult to solder surfaces Can be used in both robotic and manual soldering processes ROL1 		Pb	
SMT –	Adhesive	 ALPHA® HiTech™ AD43-9600W Good adhesion on FR4 and PMMA lens Fast curing enabling high throughput manufacturing White coloring eliminates 'flaring' during initial LED illumination 			HF
Dispensing		 ALPHA® HiTech™ SM42-1311 Non-Sagging Excellent adhesion on FR4 Resists change due to high heat post application processing (i.e., wave soldering) 			HF

CONSUMER: Lighting/LED continued

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE
SMT – Printing	Adhesive	 ALPHA® HiTech™ SM42-120P Non-Sagging Excellent adhesion on FR4 Resists change due to high heat post application processing (i.e., wave soldering) 			HF
PTH – Wave / Selective Soldering	Bar and Solid Wire Solder	 ALPHA® SACX Plus 0307 Low Silver (0.3%) for improved value vs. SAC305 Low Copper dissolution and low drossing Excellent for most standard assemblies 		Pb	
		 ALPHA® SnCX Plus 07 Silver free for best value of SnCu alloys Low Copper dissolution and low drossing 		Pb	
	Liancial Flore	 ALPHA® EF-6103 ORL0 Passes IPC J-STD-004B Best for selective soldering processes 		<u>P6</u>	
	Liquid Flux	 ALPHA® EF-6808HF ROL0 Passes IPC J-STD-004B Excellent for most standard complexity assemblies 		Pb	HF



Consumer electronic devices are becoming more and more complex in our ever connected world. From bluetooth to wired and wireless interfaces, or smart learning functionality to face, voice and fingerprint identification, even the most basic equipment is using some type of advanced technology.

Key Requirements:

- High performance under wide process conditions
- Excellent value, lowers total cost of ownership
- High mechanical and electrochemical reliability

CONSUMER: Others (Audio/Video/Toys, etc.)

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE
SMT – Printing and Dispensing		ALPHA® OM-358 SAC305 Ultralow voiding including bottom terminated components Excellent electrochemical reliability on bottom terminated components Good thermal cycling performance at temperatures <105°C ALPHA® CVP-390 SAC305 / SACX Plus 0307 Wide reflow process window Fine feature printability down to 01005 feature size Broad latitude paste for ultimate flexibility in manufacturing		Pó	HF
	Solder Paste	 Available in low silver SACX Plus alloy(s) for improved value ALPHA® OM-353 SAC305 / SACX Plus 0307 Repeatable printing down to 0.3mm/.012" pitch and 01005 passives Lowest post reflow residue spreads of Alpha's chemistries Low HIP and NWO Defects Available in low silver SACX Plus alloy(s) for improved value 		Pó	HF
		ALPHA® OM-550 HRL1 Best mechanical performance of Alpha's low temperature solder alloys Repeatable printing down to 0.3mm/.012" pitch and 01005 passives Significant reduction in warpage-induced defects such as HIP and NWO	Lis	Pö	HF
SMT –	Solder Paste	ALPHA® JP-510 SAC305 • Jettable to 0.5mm/.020" pitch • High mechanical and electrochemical reliability		P6	HF
Jetting		ALPHA® JP-501 SnBiAg • Low HIP and NWO Defects • Jettable to 0.5mm/.020" pitch	Lts	Pb	HF
SMT / PTH – Pick and Place	Preforms	ALPHA® BTC-578 Accuflux Preforms Innolot / SAC305 / Low-temp Increasing thermal conductivity and heat dissipation through void reduction Low flux residue improves electrochemical reliability Prevents mechanical stackup issues through increased solder volume	Lis	Pó	HF
		 ALPHA® Tape and Reel Preforms High solder volume precision and production yields using pick and place Available in many alloys, sizes and shapes Flux coated versions available (*some fluxes contain halogens) 	Lis	P6	HF
SMT / PTH – Point Soldering, Rework and Repair	Cored	ALPHA® Telecore® HF-850 SAC305 / SACX Plus 0307 • Performs well with all standard pad finishes • Can be used in both robotic and manual soldering processes • ROL0		Pb	HF
	Wire	 ALPHA® Telecore® XL-825 SAC305 / SACX Plus 0307 Best for difficult to solder surfaces Can be used in both robotic and manual soldering processes ROL1 		Pb	

CONSUMER: Others (Audio/Video/Toys, etc.) continued

APPLICATION	PRODUCT TYPE	PRODUCT	LOW TEMP	PB FREE	HALOGEN FREE	VOC FREE
SMT – Dispensing	Adhesive	 ALPHA® HiTech™ SM42-1311 Non-Sagging Excellent adhesion on FR4 Resists change due to high heat post application processing (i.e., wave soldering) 			HF	
SMT – Printing	Adhesive	 ALPHA® HiTech™ SM42-120P Non-Sagging Excellent adhesion on FR4 Resists change due to high heat post application processing (i.e., wave soldering) 			HF	
	Bar and Solid Wire Solder	 ALPHA® SACX Plus 0307 Low Silver (0.3%) for improved value vs. SAC305 Low Copper dissolution and low drossing Excellent for most standard assemblies 		Pb		
		 ALPHA® SnCX Plus 07 Silver free for best value of SnCu alloys Low Copper dissolution and low drossing 		Pb		
	Liquid Flux	ALPHA® EF-2210 ORL0 Passes IPC J-STD-004A VOC free		Pb		Vijc
PTH – Wave / Selective Soldering		 ALPHA® EF-6000 ORL0 Passes IPC J-STD-004A High activity, rosin-free formula can be cleaned with DI water 		Pb		
		 ALPHA® EF-6103 ORL0 Passes IPC J-STD-004B Best for selective soldering processes 		Pb		
		 ALPHA® EF-9301 ROM1 Passes IPC J-STD-004A Excellent for common boards 		Pb		
		 ALPHA® SLS-65C ORLO Passes IPC J-STD-004A Low residue, moderate activity 		<u>P6</u>	HF	





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